

Dialog Semiconductor
Bernd Müller-Allinger (Mr.)
Germany
D-73230 Kirchheim/Teck-Nabern
Neue Strasse 95
Tel: +49 (7021) 805 –721
Fax: +49 (7021) 805 –110
E-mail: Bernd.Mueller-
Allinger@diasemi.com

27-Sep-2017

Declaration letter

Dear Customer,

Our company Dialog Semiconductor hereby certifies that material used and contained in Appendix A that we supply to your company, do not contain substances of very high concern (SVHC) above the threshold of 0.1% w/w in accordance of REACH regulation EC 1907/2006 last updated 7th Jul 2017 (174 substances on the candidate list). Notwithstanding the foregoing, 4,4'-isopropylidenediphenol (Bisphenol A; BPA), CAS No. 80-05-7, is an exclusion of the above statement. The content is specified in Appendix B.

Candidate List of SVHC defines the substances published by the European Chemicals Agency (ECHA) on the current Candidate List at <https://echa.europa.eu/candidate-list-table>.

Best Regards,
Dialog Semiconductor

Bernd Müller-Allinger
Quality & Environmental System Manager

Appendix A

Material	Material Description
D2071CAE0HKAVAA1	DA9063-00HK1
D2071CAE0HKAV3A1	DA9063-3AHK1
D2071CAE0HKAV3A2	DA9063-3AHK2
D2071CAE0HKAV3F1	DA9063-3FHK1
D2071CAE0HKAVBS1	DA9063-44HK1
D2071CAE0HKTVBS1	DA9063-44HK1-A
D2071CAE0HKAVBV1	DA9063-47HK1
D2071CAE0HKAVCC1	DA9063-54HK1
D2071CAE0HKTVCC1	DA9063-54HK1-A
D2071CAE0HKAVCO1	DA9063-66HK1
D2071CAE0HKAVCQ1	DA9063-68HK1
D2071CAE0HKAVCY1	DA9063-76HK1
D1924CBEHDARV001	DA6011-00HDA1
D1924CBEHDARV002	DA6011-00HDA2
D1924CBEHDARV021	DA6011-02HDA1
D1924CBEHDARV022	DA6011-02HDA2
D1795BC-C53-VAR1	DA9052-18C51
D1921BC-C5L-V3D1	DA9053-3DC51
D1921BC-C5L-V3H2	DA9053-3HC52

Appendix B

BPA Statement based on 3rd party lab SGS standard RSTS-CHEM-239-1 test method.

1. MGC core/PP type materials contain BPA <0.3wt %.
2. Substrate material which used MGC core/PP type contain BPA <0.1wt%.
3. Product IC package which used MGC core/PP type contain BPA <0.1wt%.

Note:

Mitsubishi GAS Chemical Company, Inc. (MGC) is substrate raw material of the products.